

CHIPEX POLISH

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Compilation date: 30/03/2015

Revision No: 1

Section 1: Identification of the substance/mixture and of the company/undertaking

1.1. Product identifier

Product name: CHIPEX POLISH

1.2. Relevant identified uses of the substance or mixture and uses advised against

1.3. Details of the supplier of the safety data sheet

Company name: McCann Chemicals Limited

Kings Road Immingham North East Lincs DN40 2DW

UK

Tel: +44 (0)1469 577800 **Fax:** +44 (0)1469 577266

Email: info@mccannchemicals.com

1.4. Emergency telephone number

Emergency tel: +44 (0)1469 577800

(office hours only)

Section 2: Hazards identification

2.1. Classification of the substance or mixture

Classification under CHIP: -: R10; -: R66

Classification under CLP: Flam. Liq. 3: H226

Most important adverse effects: Flammable. Repeated exposure may cause skin dryness or cracking.

2.2. Label elements

Label elements under CLP:

Hazard statements: H226: Flammable liquid and vapour.

Signal words: Warning

Hazard pictograms: GHS02: Flame



Precautionary statements: P243: Take precautionary measures against static discharge.

P280: Wear.

P303+361+353: IF ON SKIN (or hair): Remove immediately all contaminated clothing.

Rinse skin with.

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P370+378: In case of fire: Use for extinction.

P403+235: Store in a well-ventilated place. Keep cool.

P501: Dispose of to.

Label elements under CHIP:

Risk phrases: R10: Flammable.

R66: Repeated exposure may cause skin dryness or cracking.

2.3. Other hazards

Other hazards: In use, may form flammable / explosive vapour-air mixture.

PBT: This product is not identified as a PBT/vPvB substance.

Section 3: Composition/information on ingredients

3.2. Mixtures

Non-classified ingredients:

LOW BOILING POINT HYDROGEN TREATED NAPHTHA - NAPHTHA (PETROLEUM), HYDROTREATED HEAVY

EINECS	CAS	CHIP Classification	CLP Classification	Percent
265-150-3	64742-48-9	Xn: R65; -: R10; -: R66	Asp. Tox. 1: H304; Flam. Liq. 3: H226	10-30%

Section 4: First aid measures

4.1. Description of first aid measures

Skin contact: Remove all contaminated clothes and footwear immediately unless stuck to skin. Wash

immediately with plenty of soap and water.

Eye contact: Bathe the eye with running water for 15 minutes.

Ingestion: Wash out mouth with water.

Inhalation: Consult a doctor.

4.2. Most important symptoms and effects, both acute and delayed

Skin contact: There may be mild irritation at the site of contact.

Eye contact: There may be irritation and redness.

Ingestion: There may be irritation of the throat.

Inhalation: No symptoms.

Delayed / immediate effects: Headaches or general malaise may result. There may be vomiting.

4.3. Indication of any immediate medical attention and special treatment needed

Immediate / special treatment: Not applicable.

Section 5: Fire-fighting measures

5.1. Extinguishing media

Extinguishing media: Alcohol resistant foam. Water spray. Carbon dioxide. Dry chemical powder.

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5.2. Special hazards arising from the substance or mixture

Exposure hazards: Flammable. In combustion emits toxic fumes. Forms explosive air-vapour mixture.

5.3. Advice for fire-fighters

Advice for fire-fighters: Wear self-contained breathing apparatus. Wear protective clothing to prevent contact

with skin and eyes.

Section 6: Accidental release measures

6.1. Personal precautions, protective equipment and emergency procedures

Personal precautions: Refer to section 8 of SDS for personal protection details. Notify the police and fire

brigade immediately. Eliminate all sources of ignition. Turn leaking containers leak-side

up to prevent the escape of liquid.

6.2. Environmental precautions

Environmental precautions: Do not discharge into drains or rivers. Contain the spillage using bunding.

6.3. Methods and material for containment and cleaning up

Clean-up procedures: Absorb into dry earth or sand. Transfer to a closable, labelled salvage container for

disposal by an appropriate method. Do not use equipment in clean-up procedure which

may produce sparks.

6.4. Reference to other sections

Reference to other sections: Refer to section 8 of SDS.

Section 7: Handling and storage

7.1. Precautions for safe handling

Handling requirements: Smoking is forbidden. Use non-sparking tools. Ensure there is sufficient ventilation of

the area. Avoid the formation or spread of mists in the air.

7.2. Conditions for safe storage, including any incompatibilities

Storage conditions: Store in cool, well ventilated area. Keep container tightly closed. Keep away from

sources of ignition. Prevent the build up of electrostatic charge in the immediate area.

Ensure lighting and electrical equipment are not a source of ignition.

Suitable packaging: Must only be kept in original packaging.

7.3. Specific end use(s)

Specific end use(s): No data available.

Section 8: Exposure controls/personal protection

8.1. Control parameters

Workplace exposure limits: No data available.

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DNEL/PNEC Values

DNEL / PNEC No data available.

8.2. Exposure controls

Engineering measures: Ensure there is sufficient ventilation of the area. Ensure lighting and electrical

equipment are not a source of ignition.

Respiratory protection: Respiratory protection not required.

Hand protection: Protective gloves.

Eye protection: Safety glasses. Ensure eye bath is to hand.

Skin protection: Protective clothing.

Section 9: Physical and chemical properties

9.1. Information on basic physical and chemical properties

State: Liquid

Colour: Beige

Odour: Characteristic odour

Solubility in water: Insoluble

Also soluble in: Most organic solvents.

Viscosity: Viscous

Kinematic viscosity: <=20.5

Viscosity test method: Kinematic viscosity in 10-6 m2/s at 40°C (ISO 3104/3105)

Flash point°C: 51 Relative density: 0.990

pH: 7

9.2. Other information

Other information: No data available.

Section 10: Stability and reactivity

10.1. Reactivity

Reactivity: Stable under recommended transport or storage conditions.

10.2. Chemical stability

Chemical stability: Stable under normal conditions. Stable at room temperature.

10.3. Possibility of hazardous reactions

Hazardous reactions: Hazardous reactions will not occur under normal transport or storage conditions.

Decomposition may occur on exposure to conditions or materials listed below.

10.4. Conditions to avoid

Conditions to avoid: Heat. Hot surfaces. Sources of ignition. Flames.

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10.5. Incompatible materials

Materials to avoid: Strong oxidising agents. Strong acids.

10.6. Hazardous decomposition products

Haz. decomp. products: In combustion emits toxic fumes.

Section 11: Toxicological information

11.1. Information on toxicological effects

Toxicity values: No data available.

Symptoms / routes of exposure

Skin contact: There may be mild irritation at the site of contact.

Eye contact: There may be irritation and redness.

Ingestion: There may be irritation of the throat.

Inhalation: No symptoms.

Delayed / immediate effects: Headaches or general malaise may result. There may be vomiting.

Other information: Not applicable.

Section 12: Ecological information

12.1. Toxicity

Ecotoxicity values: No data available.

12.2. Persistence and degradability

Persistence and degradability: Biodegradable.

12.3. Bioaccumulative potential

Bioaccumulative potential: No bioaccumulation potential.

12.4. Mobility in soil

Mobility: Readily absorbed into soil.

12.5. Results of PBT and vPvB assessment

PBT identification: This product is not identified as a PBT/vPvB substance.

12.6. Other adverse effects

Other adverse effects: Negligible ecotoxicity.

Section 13: Disposal considerations

13.1. Waste treatment methods

Disposal operations: Transfer to a suitable container and arrange for collection by specialised disposal

company.

Recovery operations: Use principally as a fuel or other means to generate energy. **Disposal of packaging:** Arrange for collection by specialised disposal company.

NB: The user's attention is drawn to the possible existence of regional or national

regulations regarding disposal.

[cont...]

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Section 14: Transport information

14.1. UN number

UN number: UN1139

14.2. UN proper shipping name

Shipping name: Coating Solution . 3 III (D/E)

14.3. Transport hazard class(es)

Transport class: 3 (Flammable)

14.4. Packing group

Packing group: 111

14.5. Environmental hazards

Environmentally hazardous: No Marine pollutant: No

14.6. Special precautions for user

Special precautions: No special precautions.

Section 15: Regulatory information

15.1. Safety, health and environmental regulations/legislation specific for the substance or mixture

15.2. Chemical Safety Assessment

Section 16: Other information

Other information

Other information: This safety data sheet is prepared in accordance with Commission Regulation (EU) No

453/2010.

* indicates text in the SDS which has changed since the last revision.

Phrases used in s.2 and s.3: H226: Flammable liquid and vapour.

H304: May be fatal if swallowed and enters airways.

R10: Flammable.

R65: Harmful: may cause lung damage if swallowed.

R66: Repeated exposure may cause skin dryness or cracking.

Legend to abbreviations: PNEC = predicted no effect level

DNEL = derived no effect level LD50 = median lethal dose

LC50 = median lethal concentration EC50 = median effective concentration IC50 = median inhibitory concentration

dw = dry weight
bw = body weight

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cc = closed cup

oc = open cup

MUS = mouse

GPG = guinea pig

RBT = rabbit

HAM = hamster

HMN = human

MAM = mammal

PGN = pigeon

IVN = intravenous

SCU = subcutaneous

SKN = skin

DRM = dermal

OCC = ocular/corneal

PCP = phycico-chemical properties

Legal disclaimer: The above information is believed to be correct but does not purport to be all inclusive and shall be used only as a guide. This company shall not be held liable for any damage resulting from handling or from contact with the above product.